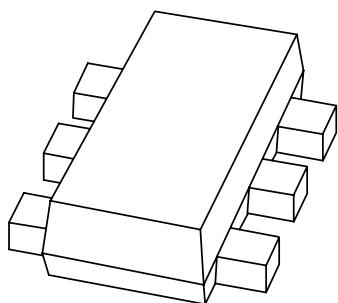


DATA SHEET



PBSS2515VPN

15 V low $V_{CE(sat)}$ NPN/PNP
transistor

Product specification
Supersedes data of 2001 Nov 07

2005 Jan 11

15 V low $V_{CE(sat)}$ NPN/PNP transistor**PBSS2515VPN****FEATURES**

- 300 mW total power dissipation
- Very small 1.6 × 1.2 mm ultra thin package
- Excellent coplanarity due to straight leads
- Low collector-emitter saturation voltage
- High current capability
- Improved thermal behaviour due to flat lead
- Replaces two SC75/SC89 packaged low V_{CEsat} transistors on same PCB area
- Reduces required PCB area
- Reduced pick and place costs.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V_{CEO}	collector-emitter voltage	15	V
I_{CM}	peak collector current	1	A
R_{CEsat}	equivalent on-resistance	<500	mΩ

PINNING

PIN	DESCRIPTION	
1, 4	emitter	TR1; TR2
2, 5	base	TR1; TR2
6, 3	collector	TR1; TR2

APPLICATION

- General purpose switching and muting
- Low frequency driver circuits
- LCD backlighting
- Audio frequency general purpose amplifier applications
- Battery driven equipment (mobile phones, video cameras and hand-held devices).

DESCRIPTION

NPN/PNP low V_{CEsat} transistor pair in a SOT666 plastic package.

MARKING

TYPE NUMBER	MARKING CODE
PBSS2515VPN	N8

ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
PBSS2515VPN	–	plastic surface mounted package; 6 leads	SOT666

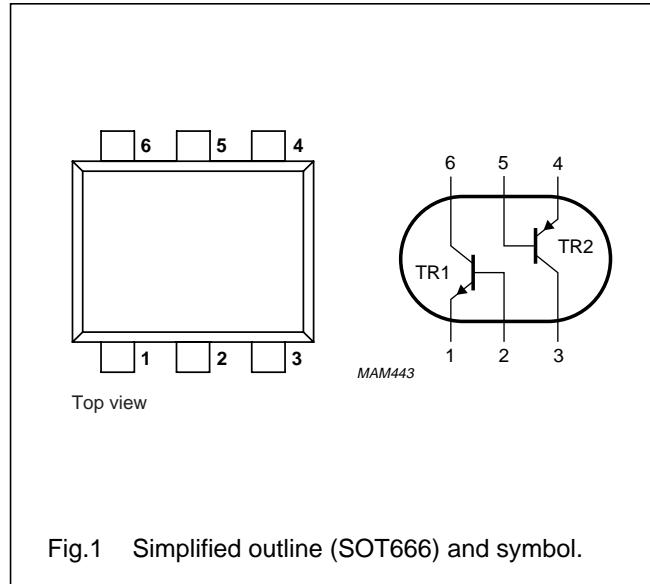


Fig.1 Simplified outline (SOT666) and symbol.

15 V low $V_{CE(sat)}$ NPN/PNP transistor

PBSS2515VPN

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transistor; for the PNP transistor with negative polarity					
V_{CBO}	collector-base voltage	open emitter	–	15	V
V_{CEO}	collector-emitter voltage	open base	–	15	V
V_{EBO}	emitter-base voltage	open collector	–	6	V
I_C	collector current (DC)		–	500	mA
I_{CM}	peak collector current		–	1	A
I_{BM}	peak base current		–	100	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$; note 1	–	200	mW
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature		–	150	°C
T_{amb}	operating ambient temperature		–65	+150	°C
Per device					
P_{tot}	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$; note 1	–	300	mW

Note

1. Transistor mounted on an FR4 printed-circuit board.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th(j-a)}$	thermal resistance from junction to ambient	notes 1 and 2	416	K/W

Notes

1. Transistor mounted on an FR4 printed-circuit board.
2. The only recommended soldering method is reflow soldering.

15 V low $V_{CE(sat)}$ NPN/PNP transistor

PBSS2515VPN

CHARACTERISTICS $T_{amb} = 25^\circ\text{C}$ unless otherwise specified.

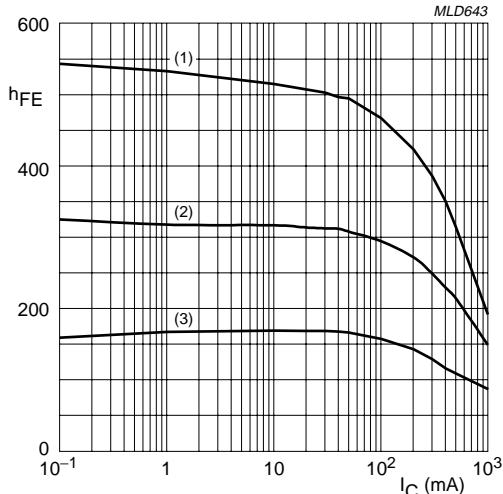
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per transistor; for the PNP transistor with negative polarity						
I_{CBO}	collector-base cut-off current	$V_{CB} = 15\text{ V}; I_E = 0\text{ A}$	—	—	100	nA
		$V_{CB} = 15\text{ V}; I_E = 0\text{ A}; T_j = 150^\circ\text{C}$	—	—	50	μA
I_{EBO}	emitter-base cut-off current	$V_{EB} = 5\text{ V}; I_C = 0\text{ A}$	—	—	100	nA
h_{FE}	DC current gain	$V_{CE} = 2\text{ V}; I_C = 10\text{ mA}$	200	—	—	
		$V_{CE} = 2\text{ V}; I_C = 100\text{ mA}; \text{note 1}$	150	—	—	
		$V_{CE} = 2\text{ V}; I_C = 500\text{ mA}; \text{note 1}$	90	—	—	
V_{CEsat}	collector-emitter saturation voltage	$I_C = 10\text{ mA}; I_B = 0.5\text{ mA}$	—	—	25	mV
		$I_C = 200\text{ mA}; I_B = 10\text{ mA}$	—	—	150	mV
		$I_C = 500\text{ mA}; I_B = 50\text{ mA}; \text{note 1}$	—	—	250	mV
R_{CEsat}	equivalent on-resistance	$I_C = 500\text{ mA}; I_B = 50\text{ mA}; \text{note 1}$	—	300	<500	$\text{m}\Omega$
V_{BEsat}	base-emitter saturation voltage	$I_C = 500\text{ mA}; I_B = 50\text{ mA}; \text{note 1}$	—	—	1.1	V
V_{BE}	base-emitter turn-on voltage	$V_{CE} = 2\text{ V}; I_C = 100\text{ mA}; \text{note 1}$	—	—	0.9	V
NPN transistor						
f_T	transition frequency	$I_C = 100\text{ mA}; V_{CE} = 5\text{ V}; f = 100\text{ MHz}$	250	420	—	MHz
C_c	collector capacitance	$V_{CB} = 10\text{ V}; I_E = I_e = 0\text{ A}; f = 1\text{MHz}$	—	4.4	6	pF
PNP transistor						
f_T	transition frequency	$I_C = -100\text{ mA}; V_{CE} = -5\text{ V}; f = 100\text{ MHz}$	100	280	—	MHz
C_c	collector capacitance	$V_{CB} = -10\text{ V}; I_E = I_e = 0\text{ A}; f = 1\text{MHz}$	—	—	10	pF

Note

1. Pulse test: $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02$.

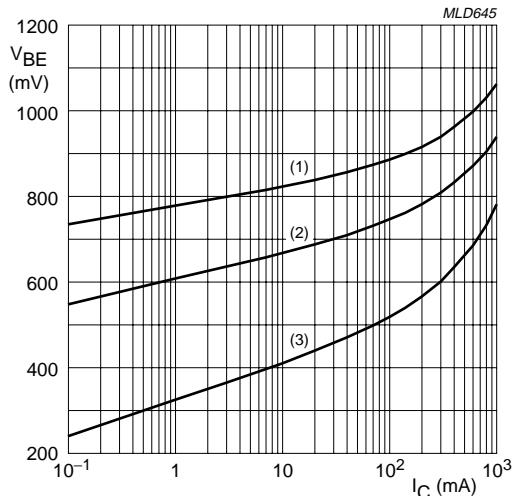
15 V low $V_{CE(sat)}$ NPN/PNP transistor

PBSS2515VPN

**TR1 (NPN)** $V_{CE} = 2$ V.

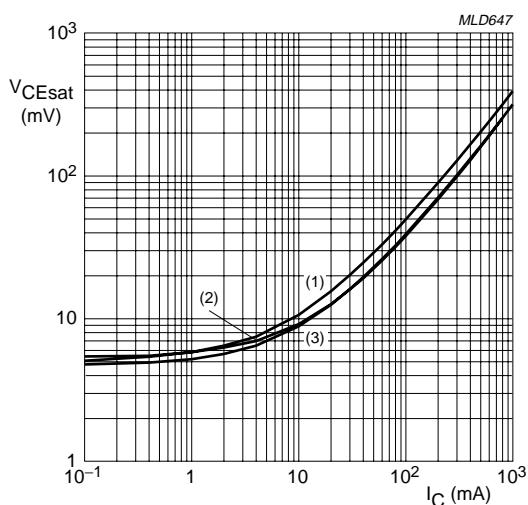
- (1) $T_{amb} = 150$ °C.
- (2) $T_{amb} = 25$ °C.
- (3) $T_{amb} = -55$ °C.

Fig.2 DC current gain as a function of collector current; typical values.

**TR1 (NPN)** $V_{CE} = 2$ V.

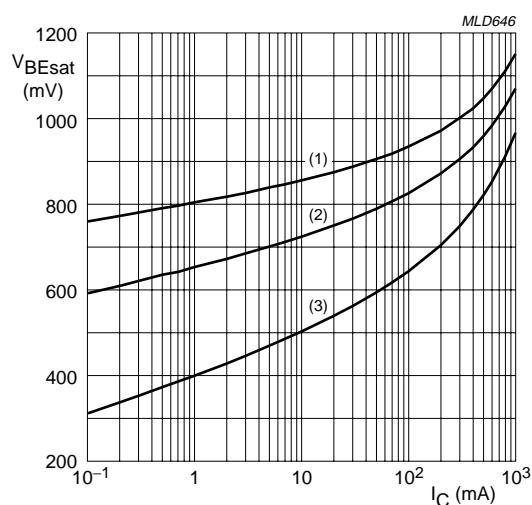
- (1) $T_{amb} = -55$ °C.
- (2) $T_{amb} = 25$ °C.
- (3) $T_{amb} = 150$ °C.

Fig.3 Base-emitter voltage as a function of collector current; typical values.

**TR1 (NPN)** $I_C/I_B = 20$.

- (1) $T_{amb} = 150$ °C.
- (2) $T_{amb} = 25$ °C.
- (3) $T_{amb} = -55$ °C.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.

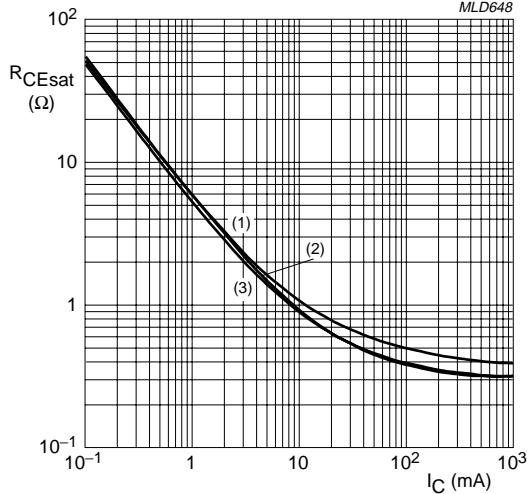
**TR1 (NPN)** $I_C/I_B = 20$.

- (1) $T_{amb} = 150$ °C.
- (2) $T_{amb} = 25$ °C.
- (3) $T_{amb} = -55$ °C.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

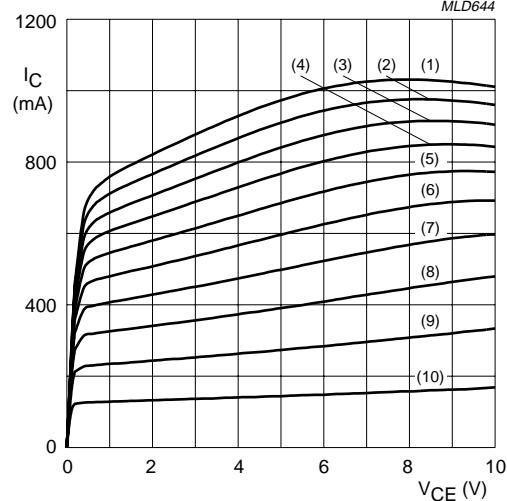
15 V low $V_{CE(sat)}$ NPN/PNP transistor

PBSS2515VPN

**TR1 (NPN)** $I_C/I_B = 20$.

- (1) $T_{amb} = 150^\circ C$.
- (2) $T_{amb} = 25^\circ C$.
- (3) $T_{amb} = -55^\circ C$.

Fig.6 Equivalent on-resistance as a function of collector current; typical values.

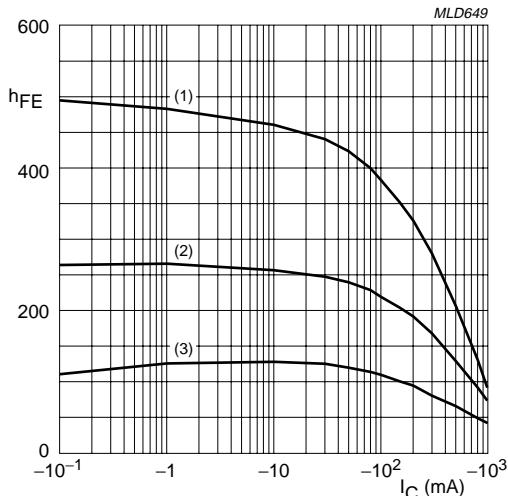
**TR1 (NPN)** $T_{amb} = 25^\circ C$.

- | | |
|----------------------|-----------------------|
| (1) $I_B = 4.6$ mA. | (6) $I_B = 2.3$ mA. |
| (2) $I_B = 4.14$ mA. | (7) $I_B = 1.84$ mA. |
| (3) $I_B = 3.68$ mA. | (8) $I_B = 1.38$ mA. |
| (4) $I_B = 3.22$ mA. | (9) $I_B = 0.92$ mA. |
| (5) $I_B = 2.76$ mA. | (10) $I_B = 0.46$ mA. |

Fig.7 Collector current as a function of collector-emitter voltage; typical values.

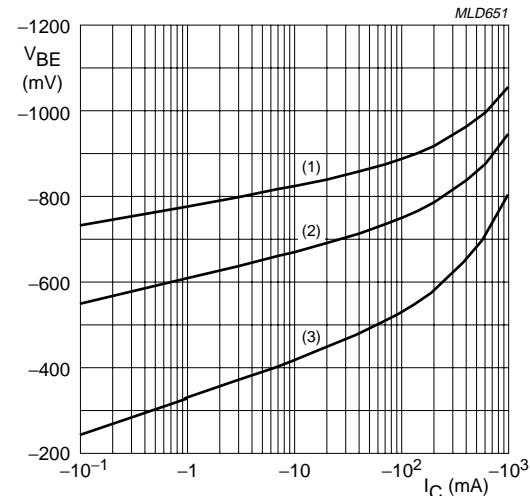
15 V low $V_{CE(sat)}$ NPN/PNP transistor

PBSS2515VPN

**TR2 (PNP)** $V_{CE} = -2\text{ V}$.

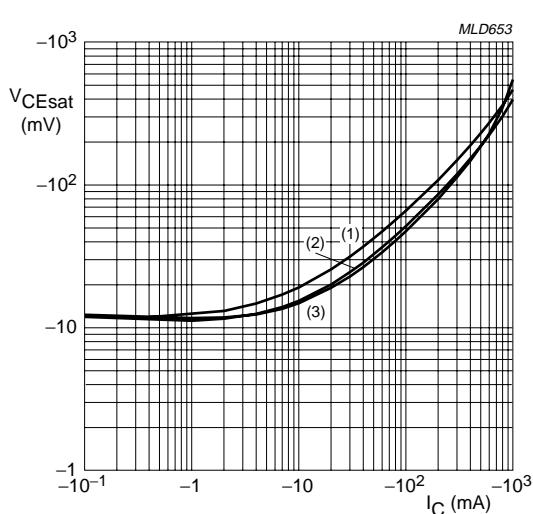
- (1) $T_{amb} = 150\text{ }^{\circ}\text{C}$.
- (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$.
- (3) $T_{amb} = -55\text{ }^{\circ}\text{C}$.

Fig.8 DC current gain as a function of collector current; typical values.

**TR2 (PNP)** $V_{CE} = -2\text{ V}$.

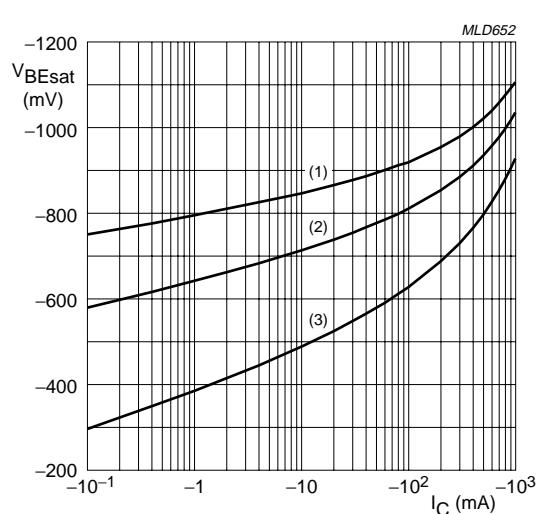
- (1) $T_{amb} = -55\text{ }^{\circ}\text{C}$.
- (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$.
- (3) $T_{amb} = 150\text{ }^{\circ}\text{C}$.

Fig.9 Base-emitter voltage as a function of collector current; typical values.

**TR2 (PNP)** $I_C/I_B = 20$.

- (1) $T_{amb} = 150\text{ }^{\circ}\text{C}$.
- (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$.
- (3) $T_{amb} = -55\text{ }^{\circ}\text{C}$.

Fig.10 Collector-emitter saturation voltage as a function of collector current; typical values.

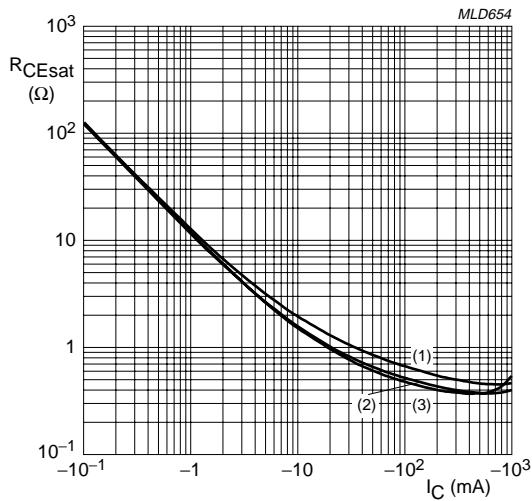
**TR2 (PNP)** $I_C/I_B = 20$.

- (1) $T_{amb} = 150\text{ }^{\circ}\text{C}$.
- (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$.
- (3) $T_{amb} = -55\text{ }^{\circ}\text{C}$.

Fig.11 Base-emitter saturation voltage as a function of collector current; typical values.

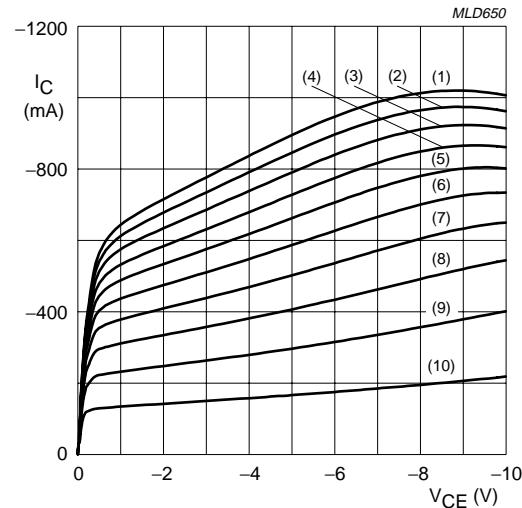
15 V low $V_{CE(sat)}$ NPN/PNP transistor

PBSS2515VPN



TR2 (PNP) $I_C/I_B = 20$.
 (1) $T_{amb} = 150$ °C.
 (2) $T_{amb} = 25$ °C.
 (3) $T_{amb} = -55$ °C.

Fig.12 Equivalent on-resistance as a function of collector current; typical values.



TR2 (PNP) $T_{amb} = 25$ °C.

- | | |
|----------------------|-----------------------|
| (1) $I_B = -7$ mA. | (6) $I_B = -3.5$ mA. |
| (2) $I_B = -6.3$ mA. | (7) $I_B = -2.8$ mA. |
| (3) $I_B = -5.6$ mA. | (8) $I_B = -2.1$ mA. |
| (4) $I_B = -4.9$ mA. | (9) $I_B = -1.4$ mA. |
| (5) $I_B = -4.2$ mA. | (10) $I_B = -0.7$ mA. |

Fig.13 Collector current as a function of collector-emitter voltage; typical values.

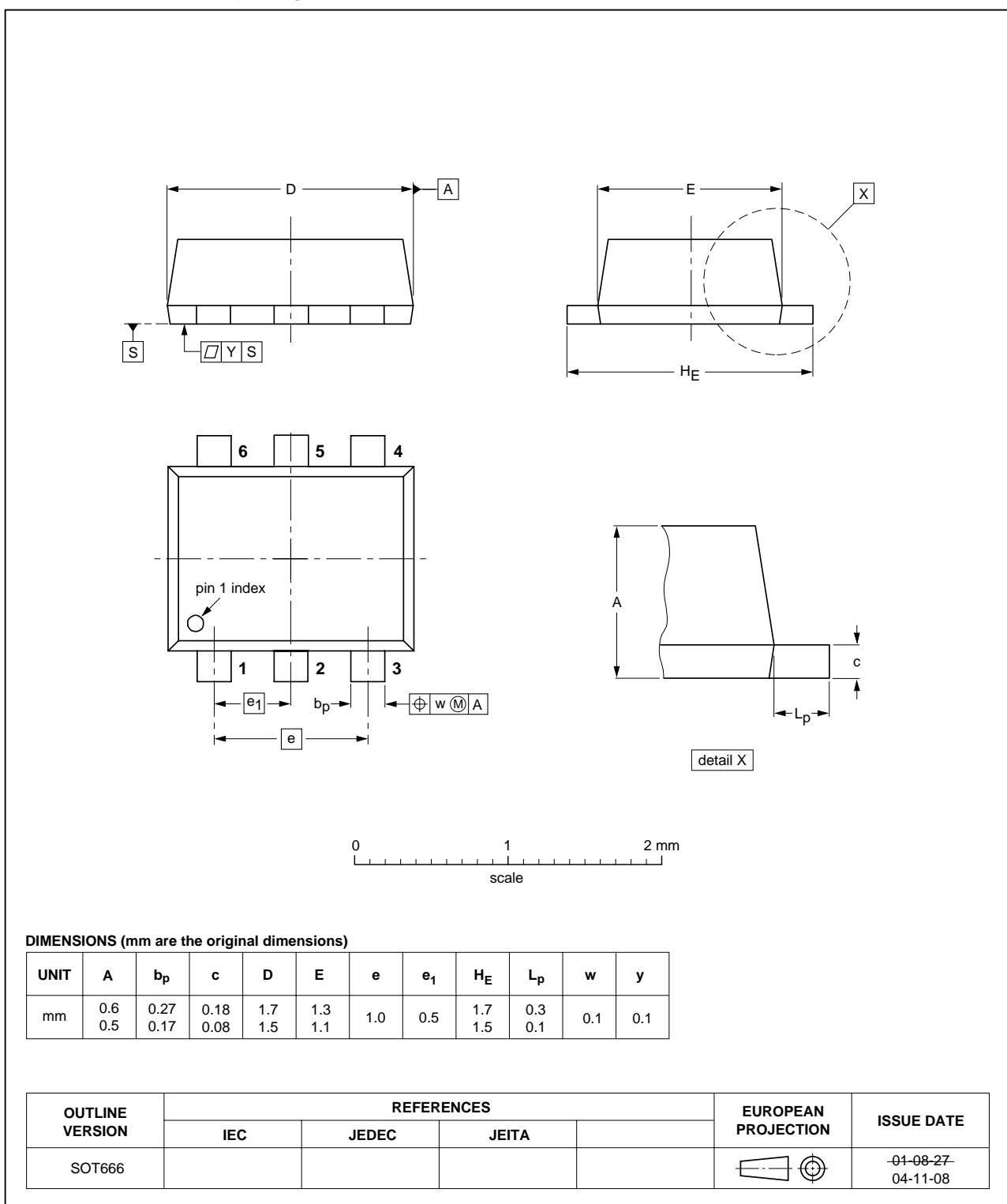
15 V low $V_{CE(sat)}$ NPN/PNP transistor

PBSS2515VPN

PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT666



DIMENSIONS (mm are the original dimensions)

UNIT	A	b_p	c	D	E	e	e_1	H_E	L_p	w	y
mm	0.6 0.5	0.27 0.17	0.18 0.08	1.7 1.5	1.3 1.1	1.0	0.5	1.7 1.5	0.3 0.1	0.1	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT666						-01-08-27- 04-11-08

15 V low $V_{CE(sat)}$ NPN/PNP transistor

PBSS2515VPN

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